



# BES2710IHC

Brief Datasheet

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## Ultra-low Power Bluetooth Audio Platform for TWS Applications with Real-time Adaptive ANC

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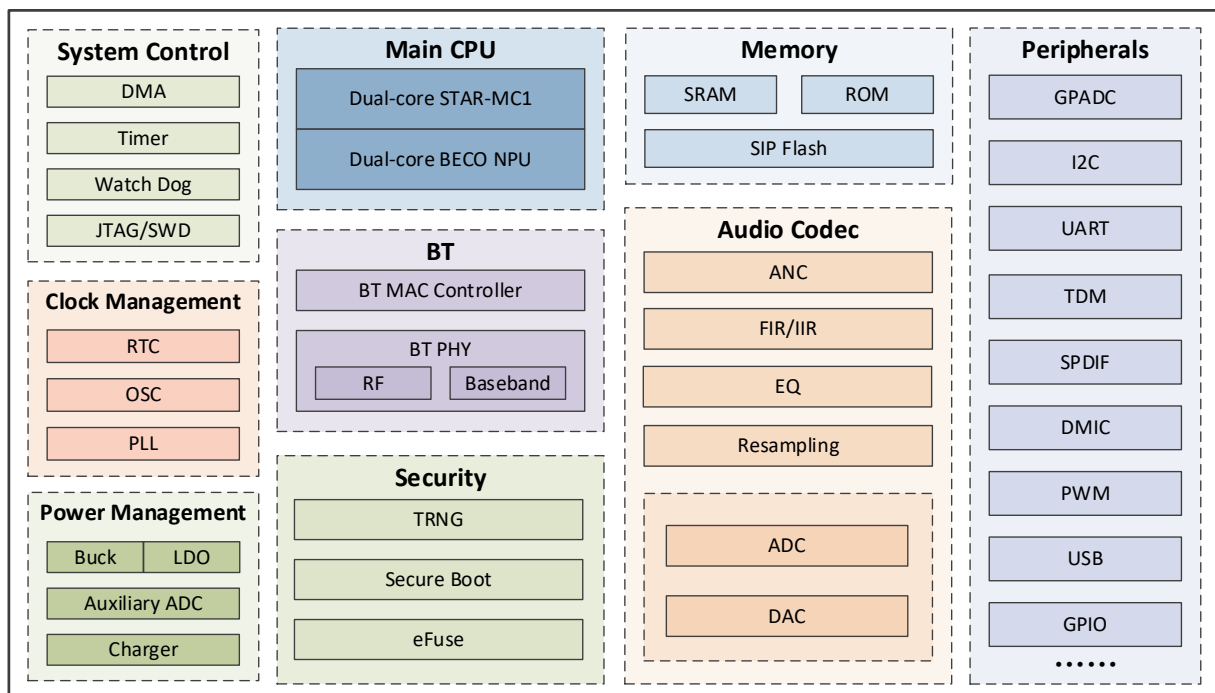
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## 1 General Description

The BES2710IHC is an ultra-low power Bluetooth audio SoC. The platform incorporates a CPU subsystem comprising a dual-core STAR-MC1 processor with a dual-core BECO NPU, a BES proprietary coprocessor for advance signal processing and NN workloads, RAM/ROM, serial flash for software features and product customization, as well as a variety of interfaces. This combination minimizes external components, reduces BOM costs and offers a cost-effective Bluetooth audio solution.

The platform incorporates a dual-mode Bluetooth 6.1 subsystem, a codec subsystem and a Power Management Unit (PMU) with an integrated charger. The highly integrated design is optimized through the use of IBRT technology, a BES patented sniffing technique that incorporates Forward Error Correction (FEC) for enhanced RF performance in TWS systems.



System Block Diagram

### 1.1 Applications

- TWS earbuds with real adaptive ANC
- Stereo Bluetooth headphones/headsets
- Other portable audio devices

## 1.2 Features & Specifications\*

CPU Subsystem	Dual-core STAR-MC1
Memory and Storage	Shared 768 KB SRAM
	Flash in package
	boot ROM
Bluetooth Subsystem	Dual-mode BT 6.1 with LE audio
Audio & Voice Features	2x DACs
	3x ADCs
Peripheral Interfaces	GPADC/I2C/UART/TDM/SPDIF/DMIC/PWM/USB/GPIO.....
Package	50-L QFN

\* The content in the table is subject to change without notice.